

|                                   |  |                         |   |                  |
|-----------------------------------|--|-------------------------|---|------------------|
| <b>Notice of References Cited</b> |  | Application/Control No. | Applicant(s)/Patent Under Reexamination<br>HIRAIWA ET AL. |                  |
|                                   |  | 10/801,718              | Examiner<br>Daniel Kim                                    | Art Unit<br>2185 |

**U.S. PATENT DOCUMENTS**

| * |   | Document Number<br>Country Code-Number-Kind Code | Date<br>MM-YYYY | Name               | Classification |
|---|---|--|-----------------|--------------------|----------------|
| * | A | US-2005/0010733                                  | 01-2005         | Mimatsu et al.     | 711/162        |
| * | B | US-2004/0039890                                  | 02-2004         | Itoh et al.        | 711/162        |
| * | C | US-2003/0200275                                  | 10-2003         | Hirabayashi et al. | 709/214        |
| * | D | US-2004/0220975                                  | 11-2004         | Carpentier et al.  | 707/200        |
|   | E | US-  |                 |                    |                |
|   | F | US-  |                 |                    |                |
|   | G | US-  |                 |                    |                |
|   | H | US-  |                 |                    |                |
|   | I | US-  |                 |                    |                |
|   | J | US-  |                 |                    |                |
|   | K | US-  |                 |                    |                |
|   | L | US-  |                 |                    |                |
|   | M | US-  |                 |                    |                |

**FOREIGN PATENT DOCUMENTS**

| * |   | Document Number<br>Country Code-Number-Kind Code | Date<br>MM-YYYY | Country | Name | Classification |
|---|---|--|-----------------|---------|------|----------------|
|   | N |  |                 |         |      |                |
|   | O |  |                 |         |      |                |
|   | P |  |                 |         |      |                |
|   | Q |  |                 |         |      |                |
|   | R |  |                 |         |      |                |
|   | S |  |                 |         |      |                |
|   | T |  |                 |         |      |                |

**NON-PATENT DOCUMENTS**

| * |   | Include as applicable: Author, Title Date, Publisher, Edition or Volume, Pertinent Pages) |
|---|---|---|
|   | U |   |
|   | V |   |
|   | W |   |
|   | X |   |

\*A copy of this reference is not being furnished with this Office action. (See MPEP § 707.05(a).)  
Dates in MM-YYYY format are publication dates. Classifications may be US or foreign.